Overview
The purpose of this notification is to communicate substrate core material change for Flash Memory Configuration PROMs packages.

Description
The manufacturer of the current substrate core material will stop production. Therefore, Xilinx qualified a new core material to continue supply and shipment of flash memory configuration PROMs packages reflected in Table 1. This enables Xilinx to better support long-term customer demand. There is no change to the fit, form, function or reliability with this change.

Xilinx will revise the corresponding material declaration data sheet (MDDS) to reflect the new material change (Refer to Xilinx.com).

Products Affected
This change affects all standard part numbers and specification control document (SCD) versions of the standard part numbers as listed in Table 1.

Table 1: Affected Device-Packages

<table>
<thead>
<tr>
<th>Device</th>
<th>Package-Pin</th>
</tr>
</thead>
<tbody>
<tr>
<td>XCF08P</td>
<td>FS(G)48</td>
</tr>
<tr>
<td>XCF16P</td>
<td>FS(G)48</td>
</tr>
<tr>
<td>XCF32P</td>
<td>FS(G)48</td>
</tr>
</tbody>
</table>

Key Dates and Ordering Information
Xilinx will start cross-shipping devices starting November 24, 2017.

Qualification Data
Xilinx has successfully completed qualification. All necessary qualification data for the new substrate core material are available upon request.

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Substrate Core Change for Flash Memory Configuration PROMs Packages

Additional Documentation

XTP476 - FAQ: Implications of XCN17007
https://secure.xilinx.com/webreg/clickthrough.do?cid=fcabb3d2-257e-4f08-ac1e-3d10a07011f2

Revision History

The following table shows the revision history for this document:

<table>
<thead>
<tr>
<th>Date</th>
<th>Version</th>
<th>Description of Revisions</th>
</tr>
</thead>
<tbody>
<tr>
<td>07/24/17</td>
<td>1.0</td>
<td>Initial release</td>
</tr>
</tbody>
</table>

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